SOLID STATE DEVICES, INC. 14830 Valley View Blvd * La Mirada, Ca 90638 Phone: (562) 404-7855 * Fax: (562) 404-1773 **75 AMP 50 VOLTS**

DESIGNER'S DATA SHEET

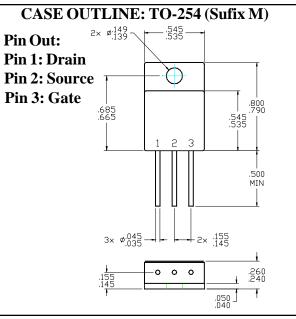
FEATURES:

- Advanced high-cell density withstands high energy
- Very low conduction and switching losses
- Fast recovery drain-to-source diode with soft recovery
- **Rugged construction with poly silicon gate**
- Ultra low RDS (on) and high transconductance •
- **Excellent high temperature stability**
- Very fast switching speed
- Fast recovery and superior dv/dt performance
- Increased reverse energy capability
- Low input and transfer capacitance for easy paralleling
- Hermetically sealed package
- TX, TXV and Space Level screening available

MAXIMUM RATINGS

CHARACTERISTIC	

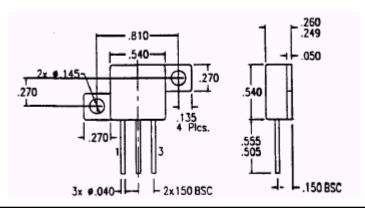
CHARACIERISTIC		SYMBOL	VALUE	UNII
Drain to Source Voltage		V _{DS}	50	Volts
Drain to Gate Voltage (RGS = $1.0 \text{ m}\Omega$)		V _{DG}	50	Volts
Gate to Source Voltage		V _{GS}	<u>+</u> 20	Volts
Continuous Drain Current	@TC=25°C @TC=100°C	I _D	56 <u>1/</u> 46	Amps
Operating and Storage Temperature		Top & Tstg	-55 to +175	°C
Thermal Resistance, Junction to Case		R _{ղJC}	1	°C/W
Total Device Dissipation	@ TC = 25°C @ TC = 55°C	PD	150 120	Watts



CASE OUTLINE: TO-254Z (Sufix Z)

SVMDOI

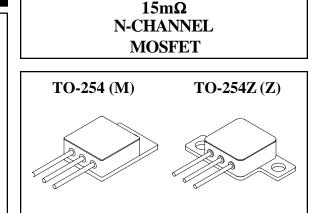
Pin Out: Pin 1: Drain **Pin 2: Source** Pin 3: Gate



Available with Glass or Ceramic Seals. Contact Facory for details.

NOTE: All specifications are subject to change without notification. SCDs for these devices should be reviewed by SSDI prior to release.

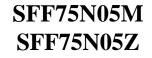
DATA SHEET #: F00257E



VATTE

TINITT

SFF75N05M SFF75N05Z



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ELECTRICAL CHARACTERISTICS @ $T_J = 25^{\circ}C$ (Unless Otherwise Specified)									
RATING		SYMBOL	MIN	ТҮР	MAX	UNIT			
Drain to Source Breakdown Voltage (VGS =0 V, ID = 250µA)		BV _{DSS}	50	-	-	v			
Drain to Source on State Resistance (VGS = 10 V,Tc = 150°C)	ID=37.5A ID=75A ID=37.5A	R _{DS(on)}		13 15 19	15 17	Υ Ω			
On State Drain Current (VDS > ID(on) x RDS(on) Max, VGS = 10 V)		I _{D(on)}	75	-	-	Α			
Gate Threshold Voltage (VDS = VGS, ID = 250µA)		V _{GS(th)}	2	-	4.0	v			
Forward Transconductance (VDS > ID(on) X RDS (on) Max, IDS=20 Amps)		gfs	15	35	-	Smho			
Zero Gate Voltage Drain Current $(V_{DS} = max rated voltage, V_{GS} = 0 V)$ $(V_{DS} = 80\% rated V_{DS}, V_{GS} = 0V, T_A = 125^{\circ}C)$		I _{DSS}	-	-	10 100	μΑ			
Gate to Source Leakage Forward Gate to Source Leakage Reverse	At rated VGS	I _{GSS}	-	-	100 100	nA			
Total Gate Charge Gate to Source Charge Gate to Drain Charge	VGS = 10 V 80% rated VDS Rated ID	Qg Qgs Qgd	- -	80 13 40	100 20 55	nC			
Turn on Delay Time Rise Time Turn off DelayTime Fall Time	VDD =50% rated VDS rated ID RG=9.1Ω	td (on) tr td (off) tf	- - -	20 35 65 40	40 70 130 80	nsec			
Diode Forvard Voltage $(I_S = rated I_D, V_{GS} = 0V, T_J = 25^{\circ}C)$		V _{SD}	-	1.47	1.6	v			
Diode Reverse Recovery Time Reverse Recovery Charge	$TJ = 25^{\circ}C$ IF = 10A di/dt = 100A/ μ sec	t _{rr} Q _{RR}	-	70 40/35	150	nsec			
Input Capacitance Output Capacitance Reverse Transfer Capacitance	VGS =0 Volts VDS =25 Volts f =1 MHz	Ciss Coss Crss	- -	2600 700 260	2900 1100 275	pF			

For thermal derating curves and other characteristic curves please contact SSDI Marketing Department.

NOTES:

1/ Maximum current limited by package, die rated at 75A.